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# Onsemi

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# **IGBT** for Automotive **Applications**

## 650 V, 30 A, D<sup>2</sup>PAK

#### Features

- Maximum Junction Temperature:  $T_J = 175^{\circ}C$
- High Speed Switching Series
- $V_{CE(sat)} = 1.6 V (typ.) @ I_C = 30 A$
- Low VF Soft Recovery Co-packaged Diode
- AEC-Q101 Qualified
- 100% of the Parts are Dynamically Tested (Note 1)

#### **Typical Applications**

- Automotive On Board Charger
- Automotive DC/DC Converter for HEV

#### MAXIMUM RATINGS (T<sub>C</sub> = 25°C unless otherwise stated)

Symbol	Value	Unit
V <sub>CES</sub>	650	V
V <sub>GES</sub>	±20	V
V <sub>GES</sub>	±30	V
Ι <sub>C</sub>	60	А
	30	А
I <sub>CM</sub>	120	А
١ <sub>F</sub>	40	А
	20	А
I <sub>FM</sub>	120	А
PD	220	W
	110	W
T <sub>J</sub> , T <sub>STG</sub>	–55 to +175	°C
	V <sub>CES</sub> V <sub>GES</sub> V <sub>GES</sub> I <sub>C</sub> I <sub>C</sub> I <sub>F</sub> I <sub>FM</sub> P <sub>D</sub>	VCES 650   VGES ±20   VGES ±30   IC 60   IC 40   IF 40   IF 20   IFM 20   IFM 120   IFM 120   IFM 120   IFM 120   IFM 50   IFM 50   IFM 50

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

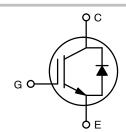
- 1.  $V_{CC} = 400 \text{ V}, V_{GE} = 15 \text{ V}, I_C = 90 \text{ A}, R_G = 100 \Omega$ , Inductive Load 2. Repetitive rating: pulse width limited by max. Junction temperature
- 3. Surface-mounted on FR4 board using 1 in<sup>2</sup> pad size, 1 oz Cu pad.
- 4. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.



## **ON Semiconductor®**

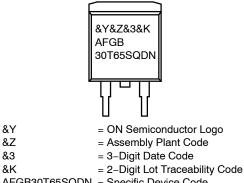
#### www.onsemi.com

BV <sub>CES</sub>	V <sub>CE(sat)</sub> TYP	I <sub>C</sub> MAX
650 V	1.6 V	120 A





#### MARKING DIAGRAM



AFGB30T65SQDN = Specific Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
AFGB30T65SQDN	D2PAK (TO-263)	800 Units / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

#### Table 1. THERMAL RESISTANCE RATINGS

Parameter	Symbol	Мах	Unit
Thermal Resistance Junction-to-Case, for IGBT	R <sub>θJC</sub>	0.68	°C/W
Thermal Resistance Junction-to-Case, for Diode	R <sub>θJC</sub>	1.55	
Thermal Resistance Junction-to-Ambient	R <sub>θJA</sub>	40	

#### Table 2. ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = $25^{\circ}$ C unless otherwise stated)

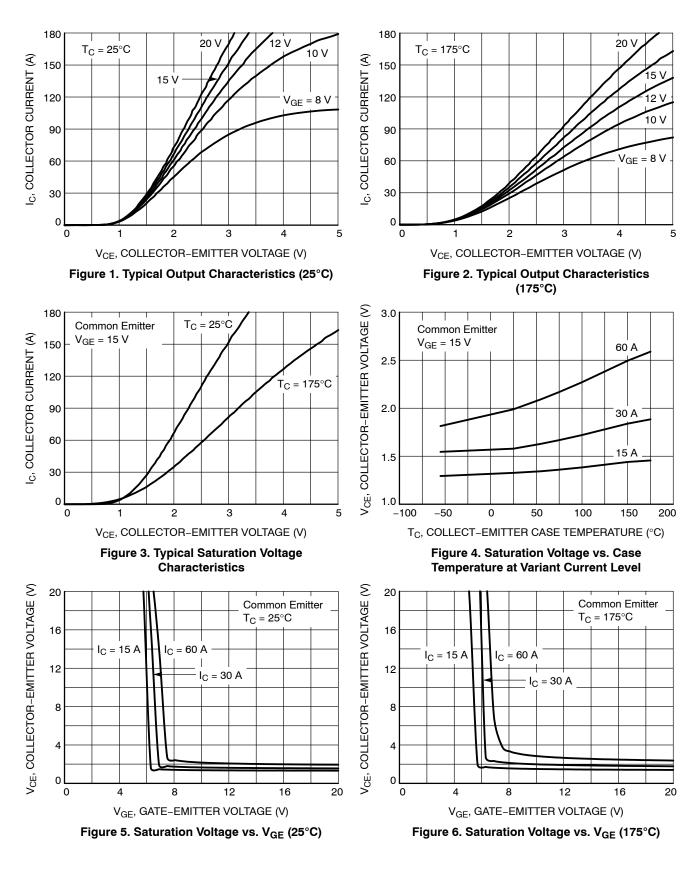
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•		•	•	-	•
Collector-to-Emitter Breakdown Voltage	BV <sub>CES</sub>	$V_{GE}$ = 0 V, I <sub>C</sub> = 1 mA	650	-	-	V
Temperature Coefficient of Breakdown Voltage	$\Delta V_{CES} / \Delta T_J$	$V_{GE}$ = 0 V, I <sub>C</sub> = 1 mA	-	0.6	-	V/°C
Collector Cut-Off Current	I <sub>CES</sub>	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μΑ
G-E Leakage Current	I <sub>GES</sub>	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
ON CHARACTERISTICS					-	
Gate Threshold Voltage	V <sub>GE(th)</sub>	$V_{GE} = V_{CE}$ , $I_C = 30$ mA	3.0	4.5	6.0	V
Collector-to-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	$I_{C}$ = 30 A, $V_{GE}$ = 15 V, $T_{C}$ = 25°C	-	1.6	2.1	V
		$I_{C}$ = 30 A, $V_{GE}$ = 15 V, $T_{C}$ = 175°C	-	1.92	-	V
DYNAMIC CHARACTERISTICS	-		-	-	-	-
Input Capacitance	Cies	$V_{CE}$ = 30 V, $V_{GE}$ = 0 V, f = 1 MHz	-	1871	-	pF
Output Capacitance	C <sub>oes</sub>		-	44	_	-
Reverse Transfer Capacitance	C <sub>res</sub>		-	7	-	
SWITCHING CHARACTERISTICS			<u>.</u>	•		
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{CC}$ = 400 V, I_C = 30 A, R_G = 6 $\Omega,$ $V_{GE}$ = 15 V,	-	14.5	_	ns
Rise Time	tr	v <sub>GE</sub> = 15 v, Inductive Load, T <sub>C</sub> = 25°C	-	16	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>		-	63.2	-	ns
Fall Time	t <sub>f</sub>		-	8.3	-	ns
Turn–On Switching Loss	Eon		-	0.783	-	mJ
Turn-Off Switching Loss	E <sub>off</sub>		-	0.160	-	mJ
Total Switching Loss	E <sub>ts</sub>		-	0.943	-	mJ
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{CC}$ = 400 V, I <sub>C</sub> = 30 A, R <sub>G</sub> = 6 $\Omega$ , V <sub>GE</sub> = 15 V,	-	12.8	-	ns
Rise Time	t <sub>r</sub>	V <sub>GE</sub> = 15 V, Inductive Load, T <sub>C</sub> = 175°C	-	20.8	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>		-	67.2	-	ns
Fall Time	t <sub>f</sub>		-	11.5	-	ns
Turn-On Switching Loss	E <sub>on</sub>		-	1.01	-	mJ
Turn–Off Switching Loss	E <sub>off</sub>		-	0.369	-	mJ
Total Switching Loss	E <sub>ts</sub>		-	1.379	-	mJ
Total Gate Charge	Qg	$V_{CE}$ = 400 V, I <sub>C</sub> = 30 A,	-	56	-	nC
Gate-to-Emitter Charge	Q <sub>ge</sub>	V <sub>GE</sub> = 15 V	-	11	-	nC
Gate-to-Collector Charge	Q <sub>gc</sub>		-	14	_	nC

#### Table 2. ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = $25^{\circ}$ C unless otherwise stated)

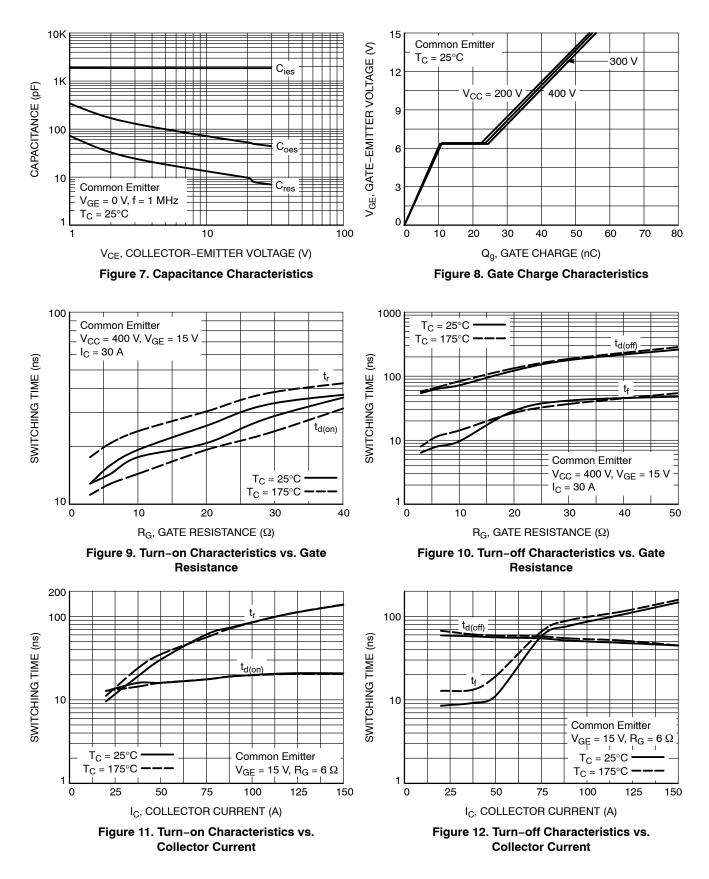
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
DIODE CHARACTERISTICS							
Diode Forward Voltage	V <sub>FM</sub>	I <sub>F</sub> = 20 A	-	1.5	2.1	V	
Reverse Recovery Energy	E <sub>rec</sub>	I <sub>F</sub> = 20 A	-	22	-	Lμ	
Diode Reverse Recovery Time	t <sub>rr</sub>	dI <sub>F</sub> /dt = 200 A/µs, T <sub>C</sub> = 25°C	-	131	-	ns	
Diode Reverse Recovery Charge	Q <sub>rr</sub>		-	348	-	nC	
Reverse Recovery Energy	E <sub>rec</sub>	I <sub>F</sub> = 20 A dI <sub>F</sub> /dt = 200 A/μs, T <sub>C</sub> = 175°C	-	100	-	Lμ	
Diode Reverse Recovery Time	t <sub>rr</sub>		-	245	-	ns	
Diode Reverse Recovery Charge	Q <sub>rr</sub>		-	961	-	nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

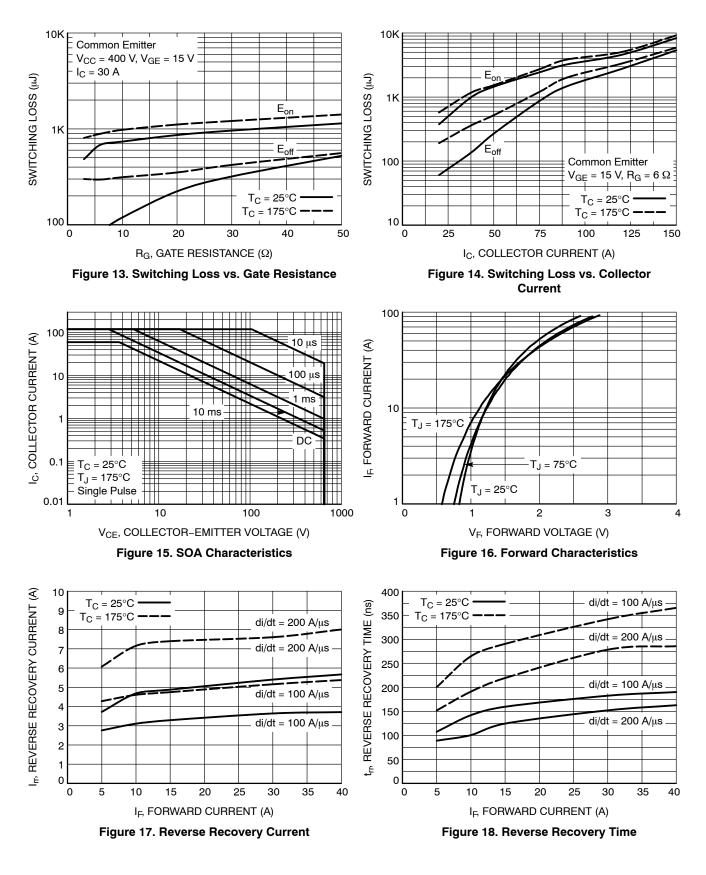
#### **TYPICAL CHARACTERISTICS**



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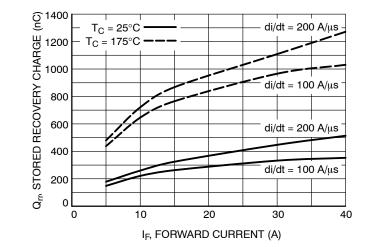
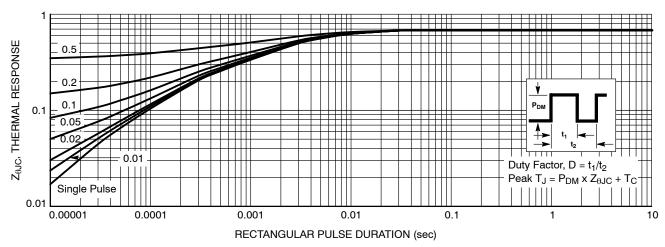
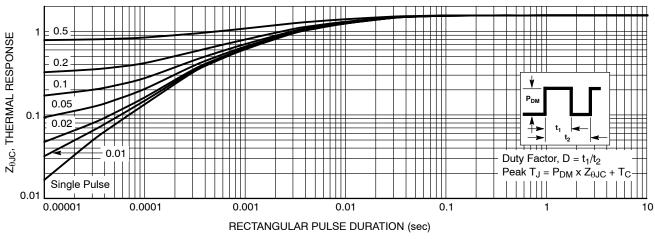


Figure 19. Stored Charge



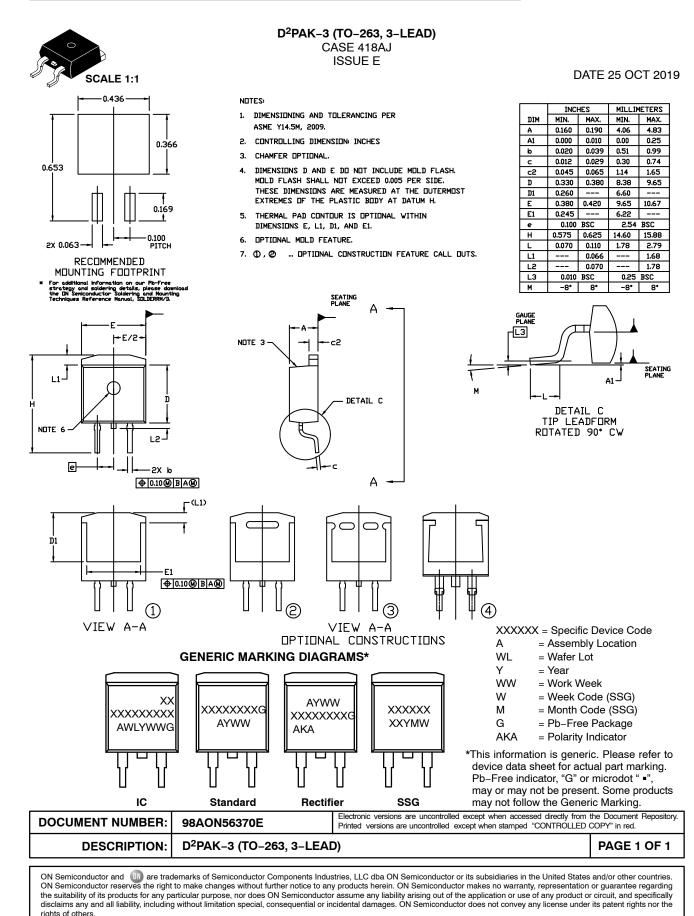






## **MECHANICAL CASE OUTLINE**





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